



STR60100CB

Surface Mount Low V_F Schottky Barrier Rectifier

Voltage

100 V

Current

60 A

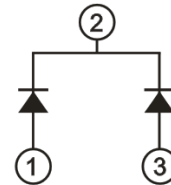
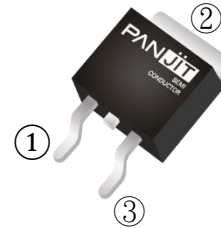
Features

- Low power loss, high efficiency
- High surge current capability
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

- Case : TO-263 Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 1.38 grams

TO-263



Maximum Ratings and Thermal Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	100	V
Maximum RMS Voltage		V_{RMS}	70	V
Maximum DC Blocking Voltage		V_{DC}	100	V
Maximum Average Forward Current	per device	$I_{F(AV)}$	60	A
	per diode		30	
Peak Forward Surge Current : 8.3 ms Single Half Sine-Wave Superimposed On Rated Load Per Diode		I_{FSM}	210	A
Typical Junction Capacitance Measured at 1 MHZ And Applied $V_R = 4\text{ V}$		C_J	1400	pF
Typical Thermal Resistance	(Note 1)	$R_{\theta JA}$	52	$^\circ\text{C/W}$
	(Note 2)	$R_{\theta JC}$	7.5	
	(Note 2)	$R_{\theta JL}$	5.5	
Operating Junction Temperature Range		T_J	-55~150	$^\circ\text{C}$
Storage Temperature Range		T_{STG}	-55~150	$^\circ\text{C}$



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Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Forward Voltage Per Diode	V_F	$I_F = 1\text{ A}, T_J = 25^\circ\text{C}$	-	0.37	-	V
		$I_F = 15\text{ A}, T_J = 25^\circ\text{C}$	-	0.6	-	
		$I_F = 30\text{ A}, T_J = 25^\circ\text{C}$	-	-	0.83	
		$I_F = 1\text{ A}, T_J = 125^\circ\text{C}$	-	0.24	-	
		$I_F = 15\text{ A}, T_J = 125^\circ\text{C}$	-	0.58	-	
		$I_F = 30\text{ A}, T_J = 125^\circ\text{C}$	-	0.73	-	
Reverse Current Per Diode ^(Note 3)	I_R	$V_R = 80\text{ V}, T_J = 25^\circ\text{C}$	-	7	-	μA
		$V_R = 100\text{ V}, T_J = 25^\circ\text{C}$	-	-	100	
		$V_R = 100\text{ V}, T_J = 125^\circ\text{C}$	-	11	-	mA

NOTES :

1. Mounted on a FR4 PCB, single-sided copper, standard footprint.
2. Mounted on a FR4 PCB, single-sided copper, with 100 cm² copper pad area.
3. Short duration pulse test used to minimize self-heating effect.



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TYPICAL CHARACTERISTIC CURVES

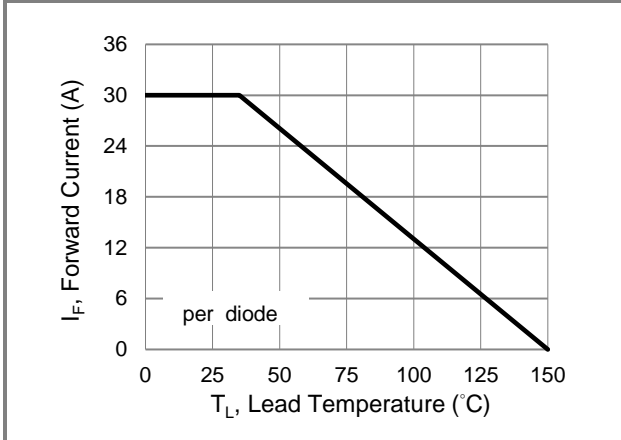


Fig.1 Forward Current Derating Curve

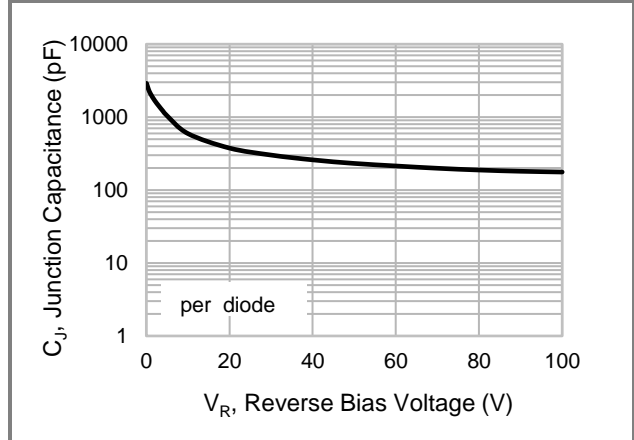


Fig.2 Typical Junction Capacitance

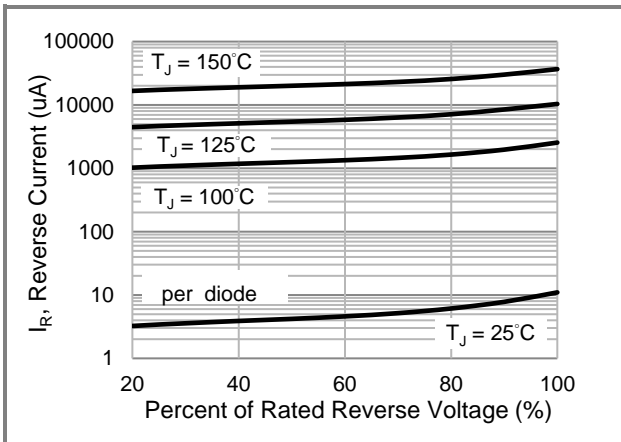


Fig.3 Typical Reverse Characteristics

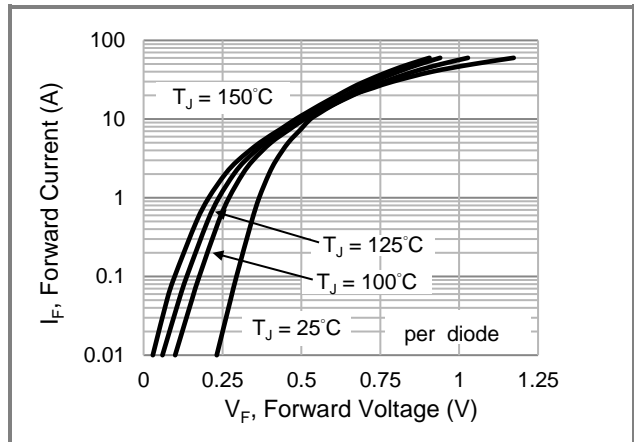


Fig.4 Typical Forward Characteristics

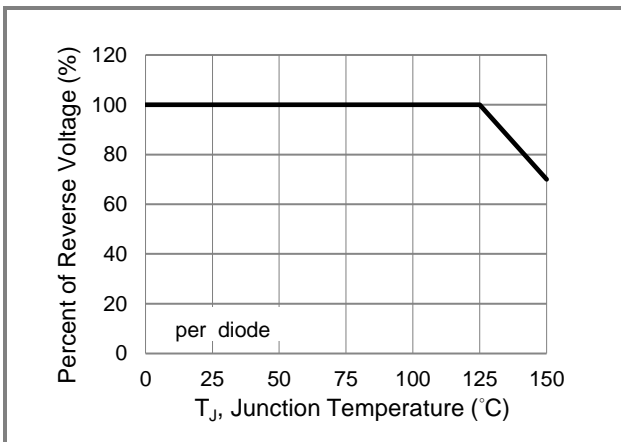


Fig.5 Operating Temperature Derating Curve



STR60100CB

Part No. Packing Code Version

Part No. Packing Code	Package Type	Packing Type	Marking	Version
STR60100CB_R2_00001	TO-263	800 pcs / 13" reel	STR60100CB	Halogen free RoHS compliant

Packaging Information & Mounting Pad Layout

